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#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Not For New Designs
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	LVD, POR, PWM
Number of I/O	13
Program Memory Size	1.5KB (1.5K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 × 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 4x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	16-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	16-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68hc908qy2mdte

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Analog-to-Digital Converter (ADC)



## 4.6 Input/Output Registers

The AWU shares registers with the keyboard interrupt (KBI) module and the port A I/O module. The following I/O registers control and monitor operation of the AWU:

- Port A data register (PTA)
- Keyboard interrupt status and control register (KBSCR)
- Keyboard interrupt enable register (KBIER)

## 4.6.1 Port A I/O Register

The port A data register (PTA) contains a data latch for the state of the AWU interrupt request, in addition to the data latches for port A.



Figure 4-2. Port A Data Register (PTA)

## AWUL — Auto Wakeup Latch

This is a read-only bit which has the value of the auto wakeup interrupt request latch. The wakeup request signal is generated internally. There is no PTA6 port or any of the associated bits such as PTA6 data direction or pullup bits.

1 = Auto wakeup interrupt request is pending

0 = Auto wakeup interrupt request is not pending

## NOTE

PTA5–PTA0 bits are not used in conjuction with the auto wakeup feature. To see a description of these bits, see 12.2.1 Port A Data Register.

## 4.6.2 Keyboard Status and Control Register

The keyboard status and control register (KBSCR):

- Flags keyboard/auto wakeup interrupt requests
- Acknowledges keyboard/auto wakeup interrupt requests
- Masks keyboard/auto wakeup interrupt requests







## LVIPWRD — LVI Power Disable Bit

LVIPWRD disables the LVI module.

- 1 = LVI module power disabled
- 0 = LVI module power enabled

## LVI5OR3 — LVI 5-V or 3-V Operating Mode Bit

LVI5OR3 selects the voltage operating mode of the LVI module. The voltage mode selected for the LVI should match the operating  $V_{DD}$  for the LVI's voltage trip points for each of the modes.

1 = LVI operates in 5-V mode

0 = LVI operates in 3-V mode

## NOTE

The LVI5OR3 bit is cleared by a power-on reset (POR) only. Other resets will leave this bit unaffected.

## SSREC — Short Stop Recovery Bit

SSREC enables the CPU to exit stop mode with a delay of 32 BUSCLKX4 cycles instead of a 4096 BUSCLKX4 cycle delay.

1 = Stop mode recovery after 32 BUSCLKX4 cycles

0 = Stop mode recovery after 4096 BUSCLKX4 cycles

## NOTE

## Exiting stop mode by an LVI reset will result in the long stop recovery.

The system stabilization time for power-on reset and long stop recovery (both 4096 BUSCLKX4 cycles) gives a delay longer than the LVI enable time for these startup scenarios. There is no period where the MCU is not protected from a low-power condition. However, when using the short stop recovery configuration option, the 32 BUSCLKX4 delay must be greater than the LVI's turn on time to avoid a period in startup where the LVI is not protecting the MCU.

## **STOP** — **STOP** Instruction Enable Bit

STOP enables the STOP instruction.

- 1 = STOP instruction enabled
- 0 = STOP instruction treated as illegal opcode

## COPD — COP Disable Bit

COPD disables the COP module.

- 1 = COP module disabled
- 0 = COP module enabled



## Chapter 7 Central Processor Unit (CPU)

## 7.1 Introduction

The M68HC08 CPU (central processor unit) is an enhanced and fully object-code-compatible version of the M68HC05 CPU. The *CPU08 Reference Manual* (document order number CPU08RM/AD) contains a description of the CPU instruction set, addressing modes, and architecture.

## 7.2 Features

Features of the CPU include:

- Object code fully upward-compatible with M68HC05 Family
- 16-bit stack pointer with stack manipulation instructions
- 16-bit index register with x-register manipulation instructions
- 8-MHz CPU internal bus frequency
- 64-Kbyte program/data memory space
- 16 addressing modes
- Memory-to-memory data moves without using accumulator
- Fast 8-bit by 8-bit multiply and 16-bit by 8-bit divide instructions
- Enhanced binary-coded decimal (BCD) data handling
- Modular architecture with expandable internal bus definition for extension of addressing range beyond 64 Kbytes
- Low-power stop and wait modes

## 7.3 CPU Registers

Figure 7-1 shows the five CPU registers. CPU registers are not part of the memory map.



## 7.3.3 Stack Pointer

The stack pointer is a 16-bit register that contains the address of the next location on the stack. During a reset, the stack pointer is preset to \$00FF. The reset stack pointer (RSP) instruction sets the least significant byte to \$FF and does not affect the most significant byte. The stack pointer decrements as data is pushed onto the stack and increments as data is pulled from the stack.

In the stack pointer 8-bit offset and 16-bit offset addressing modes, the stack pointer can function as an index register to access data on the stack. The CPU uses the contents of the stack pointer to determine the conditional address of the operand.



Figure 7-4. Stack Pointer (SP)

#### NOTE

The location of the stack is arbitrary and may be relocated anywhere in random-access memory (RAM). Moving the SP out of page 0 (\$0000 to \$00FF) frees direct address (page 0) space. For correct operation, the stack pointer must point only to RAM locations.

## 7.3.4 Program Counter

The program counter is a 16-bit register that contains the address of the next instruction or operand to be fetched.

Normally, the program counter automatically increments to the next sequential memory location every time an instruction or operand is fetched. Jump, branch, and interrupt operations load the program counter with an address other than that of the next sequential location.

During reset, the program counter is loaded with the reset vector address located at \$FFFE and \$FFFF. The vector address is the address of the first instruction to be executed after exiting the reset state.



Figure 7-5. Program Counter (PC)



\_\_\_\_\_

Source	On any tion		Effect on CCR					ess	ode	and	Se	
Form	Operation	Description	v	н	1	N	z	С	Addr Node	Dpco	Dper	Sycle
JMP opr JMP opr JMP opr,X JMP opr,X JMP ,X	Jump	PC ← Jump Address	_	_	_	_	_	_	DIR EXT IX2 IX1 IX	BC CC DC EC FC	dd hh II ee ff ff	2 3 4 3 2
JSR opr JSR opr JSR opr,X JSR opr,X JSR ,X	Jump to Subroutine	$PC \leftarrow (PC) + n (n = 1, 2, or 3)$ $Push (PCL); SP \leftarrow (SP) - 1$ $Push (PCH); SP \leftarrow (SP) - 1$ $PC \leftarrow Unconditional Address$	_	-	-	_	-	_	DIR EXT IX2 IX1 IX	BD CD DD ED FD	dd hh ll ee ff ff	45654
LDA #opr LDA opr LDA opr,X LDA opr,X LDA opr,X LDA ,X LDA opr,SP LDA opr,SP	Load A from M	A ← (M)	0	_	_	ţ	ţ	_	IMM DIR EXT IX2 IX1 IX SP1 SP2	A6 B6 C6 D6 E6 F6 9EE6 9ED6	ii dd hh II ee ff ff ee ff	2 3 4 3 2 4 5
LDHX #opr LDHX opr	Load H:X from M	$H:X \leftarrow (M:M+1)$	0	-	-	ţ	ţ	-	IMM DIR	45 55	ii jj dd	3 4
LDX #opr LDX opr LDX opr LDX opr,X LDX opr,X LDX opr,SP LDX opr,SP LDX opr,SP	Load X from M	X ← (M)	0	_	_	ţ	ţ	_	IMM DIR EXT IX2 IX1 IX SP1 SP2	AE BE CE DE EE FE 9EEE 9EDE	ii dd hh II ee ff ff ff ee ff	2 3 4 3 2 4 5
LSL opr LSLA LSLX LSL opr,X LSL ,X LSL ,A LSL opr,SP	Logical Shift Left (Same as ASL)	Image: Contract of the second sec	ţ	_	_	ţ	ţ	ţ	DIR INH INH IX1 IX SP1	38 48 58 68 78 9E68	dd ff ff	4 1 4 3 5
LSR opr LSRA LSRX LSR opr,X LSR ,X LSR opr,SP	Logical Shift Right	$0 \rightarrow \boxed{\begin{array}{c} & & \\ & & \\ & & \\ & & \\ & b7 & b0 \end{array}} \rightarrow \boxed{C}$	ţ	_	_	0	ţ	ţ	DIR INH INH IX1 IX SP1	34 44 54 64 74 9E64	dd ff ff	4 1 4 3 5
MOV opr,opr MOV opr,X+ MOV #opr,opr MOV X+,opr	Move	$(M)_{\text{Destination}} \leftarrow (M)_{\text{Source}}$ $H:X \leftarrow (H:X) + 1 \text{ (IX+D, DIX+)}$	0	_	_	t	ţ	-	DD DIX+ IMD IX+D	4E 5E 6E 7E	dd dd dd ii dd dd	5 4 4 4
MUL	Unsigned multiply	$X:A \leftarrow (X) \times (A)$	-	0	-	-	-	0	INH	42		5
NEG opr NEGA NEGX NEG opr,X NEG ,X NEG opr,SP	Negate (Two's Complement)	$\begin{array}{l} M \leftarrow -(M) = \$00 - (M) \\ A \leftarrow -(A) = \$00 - (A) \\ X \leftarrow -(X) = \$00 - (X) \\ M \leftarrow -(M) = \$00 - (M) \\ M \leftarrow -(M) = \$00 - (M) \end{array}$	ţ	-	-	ţ	ţ	ţ	DIR INH INH IX1 IX SP1	30 40 50 60 70 9E60	dd ff ff	4 1 4 3 5
NOP	No Operation	None		-	-	-	-	-	INH	9D		1
NSA	Nibble Swap A	A ← (A[3:0]:A[7:4])	-	-	-	-	-	-	INH	62		3
ORA #opr ORA opr ORA opr ORA opr,X ORA opr,X ORA opr,SP ORA opr,SP	Inclusive OR A and M	A ← (A)   (M)	0	_	_	ţ	ţ	_	IMM DIR EXT IX2 IX1 IX SP1 SP2	AA BA CA DA EA FA 9EEA 9EDA	ii dd hh II ee ff ff ee ff	2 3 4 4 3 2 4 5
PSHA	Push A onto Stack	Push (A); SP $\leftarrow$ (SP) – 1	_	_	-	-	-	-	INH	87		2
PSHH	Push H onto Stack	Push (H); SP ← (SP) – 1	-	-	-	-	-	-	INH	8B		2
PSHX	Push X onto Stack	Push (X); SP $\leftarrow$ (SP) – 1	-	-	-	-	-	-	INH	89		2



#### **Functional Description**



## Figure 9-2. Keyboard Interrupt Block Diagram

If the MODEK bit is set, the keyboard interrupt inputs are both falling edge and low-level sensitive, and both of the following actions must occur to clear a keyboard interrupt request:

- Vector fetch or software clear A vector fetch generates an interrupt acknowledge signal to clear the interrupt request. Software may generate the interrupt acknowledge signal by writing a 1 to the ACKK bit in the keyboard status and control register (KBSCR). The ACKK bit is useful in applications that poll the keyboard interrupt inputs and require software to clear the keyboard interrupt request. Writing to the ACKK bit prior to leaving an interrupt service routine can also prevent spurious interrupts due to noise. Setting ACKK does not affect subsequent transitions on the keyboard interrupt inputs. A falling edge that occurs after writing to the ACKK bit latches another interrupt request. If the keyboard interrupt mask bit, IMASKK, is clear, the central processor unit (CPU) loads the program counter with the vector address at locations \$FFE0 and \$FFE1.
- Return of all enabled keyboard interrupt inputs to logic 1 As long as any enabled keyboard interrupt pin is at logic 0, the keyboard interrupt remains set. The auto wakeup interrupt input, AWUIREQ, will be cleared only by writing to ACKK bit in KBSCR or reset.

The vector fetch or software clear and the return of all enabled keyboard interrupt pins to logic 1 may occur in any order.

If the MODEK bit is clear, the keyboard interrupt pin is falling-edge sensitive only. With MODEK clear, a vector fetch or software clear immediately clears the keyboard interrupt request.

Reset clears the keyboard interrupt request and the MODEK bit, clearing the interrupt request even if a keyboard interrupt input stays at logic 0.

The keyboard flag bit (KEYF) in the keyboard status and control register can be used to see if a pending interrupt exists. The KEYF bit is not affected by the keyboard interrupt mask bit (IMASKK) which makes it useful in applications where polling is preferred.



#### Keyboard Interrupt Module (KBI)

To determine the logic level on a keyboard interrupt pin, use the data direction register to configure the pin as an input and then read the data register.

#### NOTE

Setting a keyboard interrupt enable bit (KBIEx) forces the corresponding keyboard interrupt pin to be an input, overriding the data direction register. However, the data direction register bit must be a 0 for software to read the pin.

## 9.3.2 Keyboard Initialization

When a keyboard interrupt pin is enabled, it takes time for the internal pullup to reach a logic 1. Therefore a false interrupt can occur as soon as the pin is enabled.

To prevent a false interrupt on keyboard initialization:

- 1. Mask keyboard interrupts by setting the IMASKK bit in the keyboard status and control register.
- 2. Enable the KBI pins by setting the appropriate KBIEx bits in the keyboard interrupt enable register.
- 3. Write to the ACKK bit in the keyboard status and control register to clear any false interrupts.
- 4. Clear the IMASKK bit.

An interrupt signal on an edge-triggered pin can be acknowledged immediately after enabling the pin. An interrupt signal on an edge- and level-triggered interrupt pin must be acknowledged after a delay that depends on the external load.

Another way to avoid a false interrupt:

- 1. Configure the keyboard pins as outputs by setting the appropriate DDRA bits in the data direction register A.
- 2. Write 1s to the appropriate port A data register bits.
- 3. Enable the KBI pins by setting the appropriate KBIEx bits in the keyboard interrupt enable register.

## 9.4 Wait Mode

The keyboard module remains active in wait mode. Clearing the IMASKK bit in the keyboard status and control register enables keyboard interrupt requests to bring the MCU out of wait mode.

## 9.5 Stop Mode

The keyboard module remains active in stop mode. Clearing the IMASKK bit in the keyboard status and control register enables keyboard interrupt requests to bring the MCU out of stop mode.

## 9.6 Keyboard Module During Break Interrupts

The system integration module (SIM) controls whether the keyboard interrupt latch can be cleared during the break state. The BCFE bit in the break flag control register (BFCR) enables software to clear status bits during the break state.

To allow software to clear the keyboard interrupt latch during a break interrupt, write a 1 to the BCFE bit. If a latch is cleared during the break state, it remains cleared when the MCU exits the break state.



Oscillator Module (OSC)

## 11.3.3 XTAL Oscillator

The XTAL oscillator circuit is designed for use with an external crystal or ceramic resonator to provide an accurate clock source. In this configuration, the OSC2 pin is dedicated to the external crystal circuit. The OSC2EN bit in the port A pullup enable register has no effect when this clock mode is selected.

In its typical configuration, the XTAL oscillator is connected in a Pierce oscillator configuration, as shown in Figure 11-2. This figure shows only the logical representation of the internal components and may not represent actual circuitry. The oscillator configuration uses five components:

- Crystal, X<sub>1</sub>
- Fixed capacitor, C<sub>1</sub>
- Tuning capacitor, C<sub>2</sub> (can also be a fixed capacitor)
- Feedback resistor, R<sub>B</sub>
- Series resistor, R<sub>s</sub> (optional)

## NOTE

The series resistor ( $R_s$ ) is included in the diagram to follow strict Pierce oscillator guidelines and may not be required for all ranges of operation, especially with high frequency crystals. Refer to the crystal manufacturer's data for more information.



Note 1.

 $R_s$  can be zero (shorted) when used with higher-frequency crystals. Refer to manufacturer's data. See Chapter 16 Electrical Specifications for component value recommendations.





Input/Output Ports (PORTS)

## 12.2.1 Port A Data Register

The port A data register (PTA) contains a data latch for each of the six port A pins.



Figure 12-1. Port A Data Register (PTA)

## PTA[5:0] — Port A Data Bits

These read/write bits are software programmable. Data direction of each port A pin is under the control of the corresponding bit in data direction register A. Reset has no effect on port A data.

## AWUL — Auto Wakeup Latch Data Bit

This is a read-only bit which has the value of the auto wakeup interrupt request latch. The wakeup request signal is generated internally (see Chapter 4 Auto Wakeup Module (AWU)). There is no PTA6 port nor any of the associated bits such as PTA6 data register, pullup enable or direction.

## KBI[5:0] — Port A Keyboard Interrupts

The keyboard interrupt enable bits, KBIE5–KBIE0, in the keyboard interrupt control enable register (KBIER) enable the port A pins as external interrupt pins (see Chapter 9 Keyboard Interrupt Module (KBI)).

## 12.2.2 Data Direction Register A

Data direction register A (DDRA) determines whether each port A pin is an input or an output. Writing a 1 to a DDRA bit enables the output buffer for the corresponding port A pin; a 0 disables the output buffer.



Figure 12-2. Data Direction Register A (DDRA)

## DDRA[5:0] — Data Direction Register A Bits

These read/write bits control port A data direction. Reset clears DDRA[5:0], configuring all port A pins as inputs.

1 = Corresponding port A pin configured as output

0 = Corresponding port A pin configured as input

## NOTE

Avoid glitches on port A pins by writing to the port A data register before changing data direction register A bits from 0 to 1.



Data direction register B (DDRB) determines whether each port B pin is an input or an output. Writing a 1 to a DDRB bit enables the output buffer for the corresponding port B pin; a 0 disables the output buffer.



## Figure 12-6. Data Direction Register B (DDRB)

#### DDRB[7:0] — Data Direction Register B Bits

These read/write bits control port B data direction. Reset clears DDRB[7:0], configuring all port B pins as inputs.

1 = Corresponding port B pin configured as output

0 = Corresponding port B pin configured as input

#### NOTE

Avoid glitches on port B pins by writing to the port B data register before changing data direction register B bits from 0 to 1. Figure 12-7 shows the port B I/O logic.



#### Figure 12-7. Port B I/O Circuit

When DDRBx is a 1, reading address \$0001 reads the PTBx data latch. When DDRBx is a 0, reading address \$0001 reads the voltage level on the pin. The data latch can always be written, regardless of the state of its data direction bit. Table 12-2 summarizes the operation of the port B pins.

Table 12-2.	. Port B Pin	Functions
-------------	--------------	-----------

DDRB	РТВ	I/O Pin	Accesses to DDRB	Acc	esses to PTB
Bit	Bit	Mode	Read/Write	Read	Write
0	X <sup>(1)</sup>	Input, Hi-Z <sup>(2)</sup>	DDRB7-DDRB0	Pin	PTB7–PTB0 <sup>(3)</sup>
1	Х	Output	DDRB7-DDRB0	Pin	PTB7-PTB0

1. X = don't care

2. Hi-Z = high impedance

3. Writing affects data register, but does not affect the input.



#### System Integration Module (SIM)

The SIM counter is held in reset from the execution of the STOP instruction until the beginning of stop recovery. It is then used to time the recovery period. Figure 13-17 shows stop mode entry timing and Figure 13-18 shows the stop mode recovery time from interrupt or break.

**NOTE** To minimize stop current, all pins configured as inputs should be driven to

#### a logic 1 or logic 0. CPUSTOP ADDRESS BUS STOP ADDR STOP ADDR + 1 SAME SAME DATA BUS PREVIOUS DATA NEXT OPCODE SAME SAME R/W NOTE: Previous data can be operand data or the STOP opcode, depending on the last instruction. Figure 13-17. Stop Mode Entry Timing STOP RECOVERY PERIOD BUSCLKX4 INTERRUPT ADDRESS BUS STOP +1 STOP + 2 STOP + 2 SP SP – 1 SP – 2 SP – 3

Figure 13-18. Stop Mode Recovery from Interrupt

## 13.8 SIM Registers

The SIM has three memory mapped registers. Table 13-4 shows the mapping of these registers.

#### Table 13-4. SIM Registers

Address	Register	Access Mode
\$FE00	BSR	User
\$FE01	SRSR	User
\$FE03	BFCR	User





control the output are the ones written to last. TSC0 controls and monitors the buffered output compare function, and TIM channel 1 status and control register (TSC1) is unused. While the MS0B bit is set, the channel 1 pin, TCH1, is available as a general-purpose I/O pin.

#### NOTE

In buffered output compare operation, do not write new output compare values to the currently active channel registers. User software should track the currently active channel to prevent writing a new value to the active channel. Writing to the active channel registers is the same as generating unbuffered output compares.

## 14.4.4 Pulse Width Modulation (PWM)

By using the toggle-on-overflow feature with an output compare channel, the TIM can generate a PWM signal. The value in the TIM counter modulo registers determines the period of the PWM signal. The channel pin toggles when the counter reaches the value in the TIM counter modulo registers. The time between overflows is the period of the PWM signal

As Figure 14-3 shows, the output compare value in the TIM channel registers determines the pulse width of the PWM signal. The time between overflow and output compare is the pulse width. Program the TIM to clear the channel pin on output compare if the state of the PWM pulse is logic 1 (ELSxA = 0). Program the TIM to set the pin if the state of the PWM pulse is logic 0 (ELSxA = 1).

The value in the TIM counter modulo registers and the selected prescaler output determines the frequency of the PWM output The frequency of an 8-bit PWM signal is variable in 256 increments. Writing \$00FF (255) to the TIM counter modulo registers produces a PWM period of 256 times the internal bus clock period if the prescaler select value is 000. See 14.9.1 TIM Status and Control Register.

The value in the TIM channel registers determines the pulse width of the PWM output. The pulse width of an 8-bit PWM signal is variable in 256 increments. Writing \$0080 (128) to the TIM channel registers produces a duty cycle of 128/256 or 50%.



Figure 14-3. PWM Period and Pulse Width



## Chapter 16 Electrical Specifications

## **16.1 Introduction**

This section contains electrical and timing specifications.

## 16.2 Absolute Maximum Ratings

Maximum ratings are the extreme limits to which the microcontroller unit (MCU) can be exposed without permanently damaging it.

NOTE

This device is not guaranteed to operate properly at the maximum ratings. Refer to 16.5 5-V DC Electrical Characteristics and 16.9 3-V DC Electrical Characteristics for guaranteed operating conditions.

Characteristic <sup>(1)</sup>	Symbol	Value	Unit
Supply voltage	V <sub>DD</sub>	-0.3 to +6.0	V
Input voltage	V <sub>IN</sub>	$V_{SS}$ –0.3 to $V_{DD}$ +0.3	V
Mode entry voltage, IRQ pin	V <sub>TST</sub>	V <sub>SS</sub> –0.3 to +9.1	V
Maximum current per pin excluding PTA0–PTA5, $V_{\text{DD}}$ , and $V_{\text{SS}}$	I	±15	mA
Maximum current for pins PTA0–PTA5	I <sub>PTA0</sub> _I <sub>PTA5</sub>	±25	mA
Storage temperature	T <sub>STG</sub>	-55 to +150	°C
Maximum current out of V <sub>SS</sub>	I <sub>MVSS</sub>	100	mA
Maximum current into V <sub>DD</sub>	I <sub>MVDD</sub>	100	mA

1. Voltages references to  $V_{SS}$ .

## NOTE

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. For proper operation, it is recommended that  $V_{IN}$  and  $V_{OUT}$  be constrained to the range  $V_{SS} \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{DD}$ . Reliability of operation is enhanced if unused inputs are connected to an appropriate logic voltage level (for example, either  $V_{SS}$  or  $V_{DD}$ .)



**Electrical Specifications** 

## **16.15 Timer Interface Module Characteristics**

Characteristic	Symbol	Min	Max	Unit
Timer input capture pulse width	t <sub>TH,</sub> t <sub>TL</sub>	2	_	t <sub>cyc</sub>
Timer input capture period	t <sub>TLTL</sub>	Note <sup>(1)</sup>	_	t <sub>cyc</sub>
Timer input clock pulse width	t <sub>TCL</sub> , t <sub>TCH</sub>	t <sub>cyc</sub> + 5	—	ns

1. The minimum period is the number of cycles it takes to execute the interrupt service routine plus 1  $t_{cyc}$ .



Figure 16-11. Timer Input Timing



## **16.16 Memory Characteristics**

Characteristic	Symbol	Min	Тур	Max	Unit
RAM data retention voltage	V <sub>RDR</sub>	1.3	-	—	V
FLASH program bus clock frequency	—	1		_	MHz
FLASH read bus clock frequency	f <sub>Read</sub> <sup>(1)</sup>	0		8 M	Hz
FLASH page erase time <1 k cycles >1 k cycles	t <sub>Erase</sub>	0.9 3.6	1 4	1.1 5.5	ms
FLASH mass erase time	t <sub>MErase</sub>	4		—	ms
FLASH PGM/ERASE to HVEN setup time	t <sub>NVS</sub>	10		—	μS
FLASH high-voltage hold time	t <sub>NVH</sub>	5	_	_	μS
FLASH high-voltage hold time (mass erase)	t <sub>NVHL</sub>	100	_	_	μS
FLASH program hold time	t <sub>PGS</sub>	5	_	_	μS
FLASH program time	t <sub>PROG</sub>	30	_	40	μS
FLASH return to read time	t <sub>RCV</sub> <sup>(2)</sup>	1	_	_	μS
FLASH cumulative program HV period	t <sub>HV</sub> <sup>(3)</sup>	—	_	4	ms
FLASH endurance <sup>(4)</sup>	—	10 k	100 k	_	Cycles
FLASH data retention time <sup>(5)</sup>	_	15	100	—	Years

1.  $f_{Read}$  is defined as the frequency range for which the FLASH memory can be read.

2. t<sub>RCV</sub> is defined as the time it needs before the FLASH can be read after turning off the high voltage charge pump, by clearing HVEN to 0.

3.  $t_{HV}$  is defined as the cumulative high voltage programming time to the same row before next erase.

 $t_{HV}$  must satisfy this condition:  $t_{NVS}$  +  $t_{NVH}$  +  $t_{PGS}$  +  $(t_{PROG} \ x \ 32) \ \leq t_{HV}$  maximum.

4. Typical endurance was evaluated for this product family. For additional information on how Freescale defines *Typical Endurance*, please refer to Engineering Bulletin EB619.

5. Typical data retention values are based on intrinsic capability of the technology measured at high temperature and de-rated to 25•C using the Arrhenius equation. For additional information on how Freescale defines *Typical Data Retention*, please refer to Engineering Bulletin EB618.



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NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
- 3. THE COMPLETE JEDEC DESIGNATOR FOR THIS PACKAGE IS: HP-VFDFP-N.

4. COPLANARITY APPLIES TO LEADS AND DIE ATTACH PAD.

TITLE:THERMALLY ENHANCED DUAL	CASE NUMBER: 1452-01
FLAT NO LEAD PACKAGE (DFN)	STANDARD: NON-JEDEC
8 TERMINAL, U. 8 PITCH $(4 \times 4 \times 1)$	PACKAGE CODE: 6165 SHEET: 4 OF 5

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## NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSION TO CENTER OF LEADS WHEN FORMED PARALLEL.
- A DIMENSIONS DOES NOT INCLUDE MOLD FLASH.
- 5. ROUNDED CORNERS OPTIONAL.
- 6. 648-01 THRU -08 OBSOLETE, NEW STANDARD 648-09.

	MILLIN	MILLIMETERS INCHES MILLIMETERS		IETERS	INCHES				
DIM	MIN	MAX	MIN	MAX	DIM	MIN	MAX	MIN	MAX
А	18.80	19.55	0.740	0.770					
В	6.35	6.85	0.250	0.270					
С	3.69	4.44	0.145	0.175					
D	0.39	0.53	0.015	0.021					
F	1.02	1.77	0.040	0.070					
G	2.54	BSC	0.100 BSC						
Н	1.27 BSC 0.050 BSC								
J	0.21	0.38	0.008	0.015					
K	2.80	3.30	0.110	0.130					
L	7.50	7.74	0.295	0.305					
М	0.	10°	0.	10°					
S	0.51	1.01	0.020	0.040					
TITLE:			CASE NUMBER: 648–08						
16 LD PDIP			STANDARD: NON-JEDEC						
		PACKAGE CODE: 0006 SHEET: 2 OF 4						2 OF 4	